

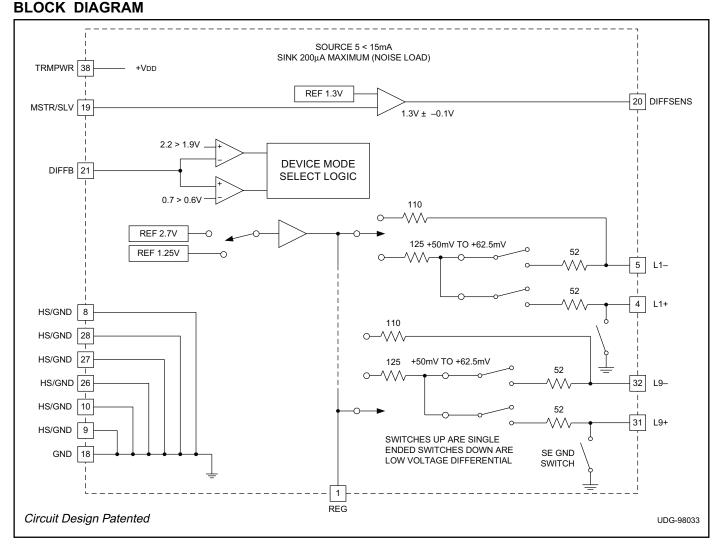
Low Voltage Differential (LVD/SE) SCSI 9 Line Terminator

FEATURES

- Auto Selection Multi-Mode Single Ended or Low Voltage Differential Termination
- 3.0V to 5.25V Operation
- Differential Failsafe Bias
- Thermal Packaging for Low Junction Temperature and Better MTBF
- Master/Slave Inputs
- Supports Active Negation
- 3pF Channel Capacitance

DESCRIPTION

The UCC5510 Multi-Mode Low Voltage Differential and Single Ended Terminator is specially designed for automatic termination of Single-Ended or Low Voltage Differential SCSI Bus. The Multi-Mode operation of this device allows for a transition system design for the next generation SCSI Parallel Interface (SPI-2). Compliant with SPI-2, with SPI and Fast-20 the UCC5510 incorporates all the functions necessary to properly terminate the SCSI Bus and has internal thermal shut down and short circuit limiting.



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ABSOLUTE MAXIMUM RATINGS

TRMPWR Voltage 6V	1
Signal Line Voltage	
Package Power Dissipation 2W	r
Storage Temperature65°C to +150°C	
Junction Temperature	
Lead Temperature (Soldering, 10sec.)+300°C	

RECOMMENDED OPERATING CONDITIONS

TRMPWR Voltage 3.0V TO 5.25V

All voltages are with respect to pin 1. Currents are positive into, negative out of the specified terminal. Consult Packaging Section of the Databook for thermal limitations and considerations of packages.

CONNECTION DIAGRAM

SSOP- MWP F	36 (Top View) Package	
		1
REG	1	36 TRMPWR
N/C	2	35 N/C
N/C	3	34 N/C
L1+	4	33 N/C
L1–	5	32 L9-
L2+	6	31 L9+
L2-	7	30 L8-
HS/GND	8	29 L8+
HS/GND	9	28 HS/GND
HS/GND	10	27 HS/GND
L3+	11	26 HS/GND
L3–	12	25 L7-
L4+	13	24 L7+
L4	14	23 L6-
L5+	15	22 L6+
L5–	16	21 DIFF B
N/C	17	20 DIFFSENS
GND	18	19 MSTR/SLV

ELECTRICAL CHARACTERISTICS: Unless otherwise specified, TA = 0°C to 70°C, TRMPWR = 3.3V.

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS		
TRMPWR Supply Current Section							
TRMPWR Supply Current				20	mA		
	Disable Terminator, in DISCNCT mode.			35	μA		
Regulator Section							
1.25V Regulator	LVD Mode	1.15	1.25	1.35	V		
1.25V Regulator Source Current	LVD Mode, Differential Sense Floating	-80	-100		mA		
1.25V Regulator Sink Current	LVD Mode, Differential Sense Floating	80	100		mA		
1.3V Regulator	DIFFSENS	1.2	1.3	1.4	V		
1.3V Regulator Source Current	DIFFSENS	-5		-15	mA		
1.3V Regulator Sink Current	DIFFSENS	50		200	μA		
2.7V Regulator	Single Ended Mode	2.5	2.7	3	V		
2.7V Regulator Source Current	Single Ended Mode	-200	-400	-800	mA		
2.7V Regulator Sink Current	Single Ended Mode	100	200	400	mA		
2.7V Regulator Dropout Voltage	V _{TRMPWR} – (V _{REG} – 3.0 Min)			200	mV		

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS			
Differential Termination Section								
Differential Impedance		100	105	110	Ω			
Common Mode Impedance		110	125	165	Ω			
Differential Bias Voltage	Drivers Tri-stated	100		125	mV			
Common Mode Bias			1.25		V			
Output Capacitance	Single Ended Measurement to Ground (Note 1)			3	pF			
Single Ended Termination Section								
Impedance		102.3	110	117.7	Ω			
Termination Current	Signal Level 0.2V	-21	-23	-24	mA			
	Signal Level 0.5V			-22.4	mA			
Output Leakage	Disabled, TRMPWR = 0V to 5.25V			400	nA			
Output Capacitance	Single Ended Measurement to Ground (Note 1)			3	pF			
Single Ended GND SW Impedance				60	Ω			
Differential Sense (DIFF B) Input Sections								
DIFFB Single Ended Threshold		0.6		0.7	V			
DIFFB Sense LVD Threshold		1.9		2.2	V			
DIFFB Input Current	V _{DIFFB} = 0V and 3.3V	-10		10	μA			
Master/Slave (MSTR/SLV) Input Section								
MSTR/SLV Threshold		0.8		2	V			
MSTR/SLV Input Current		-30		30	μA			

ELECTRICAL CHARACTERISTICS: Unless otherwise specified, TA = 0°C to 70°C, TRMPWR = 3.3V.

Note 1: Guaranteed by design. Not 100% tested in production.

PIN DESCRIPTIONS

DIFFB: DIFF SENSE filter pin should be connected to a 0.1μ F capacitor to GND and 20k resistor to SCSI/Bus DIFF SENSE Line.

DIFFSENS: The SCSI bus DIFF SENSE line is driven to 1.3V to detect what type of devices are connected to the SCSI bus.

HS/GND: Heat Sink GND. Connect to large area PC board traces to increase power dissipation capability.

GND: Power Supply Return.

L1- thru L9-: Signal line/active line for single ended or

negative line in differential applications for the SCSI bus.

L1+ thru L9+: Ground line for single ended or positive line for differential applications for the SCSI bus.

MSTR/SLV: Mode select for the non-controlling terminator. MSTR enables the 1.3V regulator, when the terminator is enabled. *Note: This function will be removed on further generations of the multimode terminators.*

REG: Regulator bypass, must be connected to a 4.7μ F capacitor.

TRMPWR: V_{IN} 3.0V to 5.25V supply.

APPLICATION INFORMATION

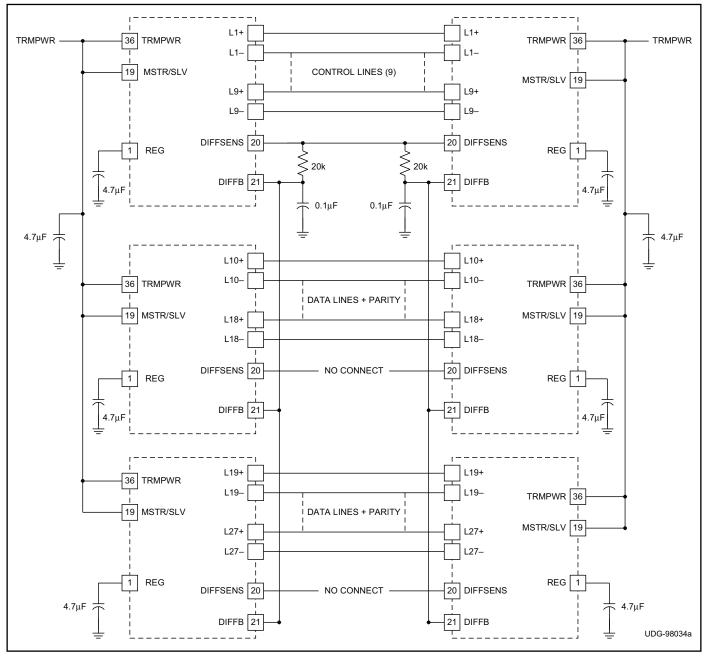


Figure 1. Application Drawing

The master is selected by placing TRMPWR on MSTR/SLV and enabling the 1.3V regulator. The master is the only terminator connected directly to the DIFF-SENS bus line. All the other terminators receive a mode signal by connecting the DIFFB pins together.

The balancing capacitor is very important during high speed operation. The typical capacitor balance between the positive (+) and negative (–) signals is 0.1pF, except

in the MWP package where between L8 and L9 the balance is 0.23pF and 0.4pF respecitvely The negative (–) signal line has a higher capacitance than the positive (+) signal line. The FQP package has typically 0.2pF less capacitance than the MWP package, where the typical balance is 0.1pF except for L8 and L3, where the balance is 0.4pF.

Note: The master/slave function will not be included in future Unitrode terminators.

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